EDGE BANDING HOT MELT

SW828J

Application: For manual machine, with low process temp., starting from 120°c/ 248°F. Good for slow feed speeds and contour manual operations

Characteristics: Provide excellent bond strength, with thin bondline, clear processing, and low-energy consumption.

Specification:

Polymer basis	Ethylene-VInyl Acetate
Viscosity at 140 °c (mPa s)	35,000 - 45,000
Softening point	75 - 85 °c
Supply form	Natural beige color in granule
Application temperature	120 - 150 °c

General guidance: For best bonding results, the materials to be used must be free of dust, oil, and grease, and be dry.

Packaging: 25 kg net weight, in non-woven bag

Storage: 24 months, in original package, cool and dry (15-35°C).

Remarks: All data indicated are characteristics represented as average values. Our technical data sheets are revised to represent the latest information. This edition is valid on the date of compilation.

TIANJIN SHENG-WANG ELECTRONIC CHEMICAL PLANT

E-mail: sales@swadhesive.com www.swhotmeltglue.com

